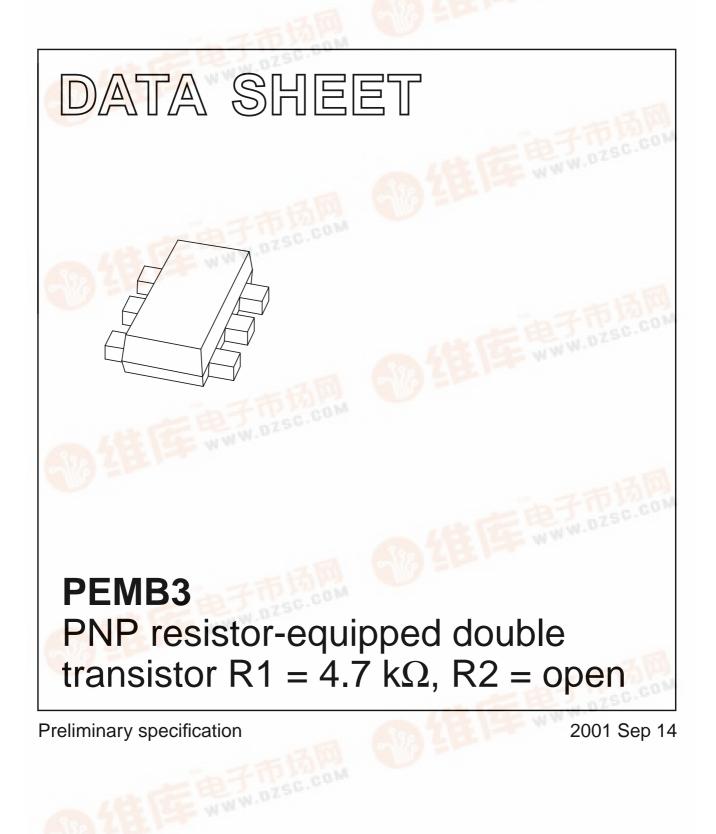
DISCRETE SEMICONDUCTORS









PNP resistor-equipped double transistor R1 = 4.7 k Ω , R2 = open

FEATURES

- 300 mW total power dissipation
- Very small 1.6 mm \times 1.2 mm \times 0.55 mm ultra thin package
- · Excellent coplanarity due to straight leads
- Reduces number of components as replacement of two SC-75/SC-89 packaged transistors
- Reduces required board space
- Reduces pick and place costs.

APPLICATIONS

- General purpose switching and amplification
- Inverter and interface circuits
- Circuit driver.

DESCRIPTION

PNP resistor-equipped double transistor in a SOT666 plastic package.

MARKING

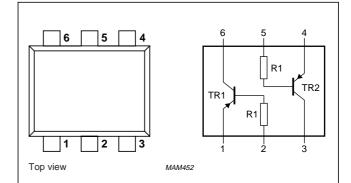
TYPE NUMBER	MARKING CODE		
PEMB3	Z3		

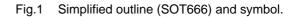
PINNING

PIN		DESCRIPTION
1, 4	emitter	TR1; TR2
2, 5	base	TR1; TR2
6, 3	collector	TR1; TR2

QUICK REFERENCE DATA

SYMBOL	PARAMETER	MAX.	UNIT	
V _{CEO}	collector-emitter voltage	-50	V	
I _{CM}	peak collector current	-100	mA	
TR1	PNP	-	_	
TR2	PNP	_	_	
R1	bias resistor	4.7	kΩ	





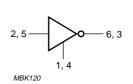


Fig.2 Equivalent inverter symbol.

PEMB3

PNP resistor-equipped double transistor R1 = 4.7 k Ω , R2 = open

PEMB3

LIMITING VALUES

In accordance with the Absolute Maximum Rating System (IEC 60134).

SYMBOL	PARAMETER	CONDITIONS	MIN.	MAX.	UNIT	
Per transi	Per transistor					
V _{CBO}	collector-base voltage	open emitter	_	-50	V	
V _{CEO}	collector-emitter voltage	open base	_	-50	V	
V _{EBO}	emitter-base voltage	open collector	_	-10	V	
VI	input voltage					
	positive		_	+10	V	
	negative		_	-40	V	
lo	output current (DC)		_	-100	mA	
I _{CM}	peak collector current		_	-100	mA	
P _{tot}	total power dissipation	$T_{amb} \le 25 \ ^{\circ}C;$ note 1	_	200	mW	
T _{stg}	storage temperature		-65	+150	°C	
Tj	junction temperature		_	150	°C	
T _{amb}	operating ambient temperature		-65	+150	°C	
Per device	9	•	ł	·	·	
P _{tot}	total power dissipation	T _{amb} ≤ 25 °C; note 1	_	300	mW	

Note

1. Transistor mounted on an FR4 printed-circuit board.

THERMAL CHARACTERISTICS

SYMBOL	PARAMETER	CONDITIONS	VALUE	UNIT	
R _{th j-a}	thermal resistance from junction to ambient	notes 1 and 2	416	K/W	

Notes

1. Transistor mounted on an FR4 printed-circuit board.

2. The only recommended soldering method is reflow soldering.

PNP resistor-equipped double transistor

PEMB3

$R1 = 4.7 \text{ k}\Omega$, R2 = open

CHARACTERISTICS

 T_{amb} = 25 °C unless otherwise specified.

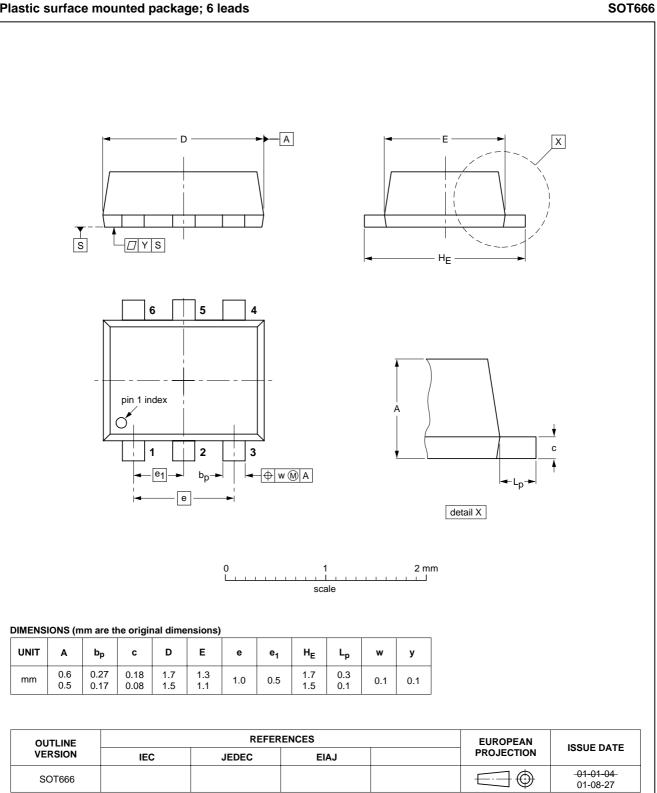
SYMBOL	PARAMETER	CONDITIONS	MIN.	TYP.	MAX.	UNIT
Per transis	Per transistor					
I _{CBO}	collector cut-off current	$I_E = 0; V_{CB} = -50 V$	-	-	-100	nA
I _{CEO}	collector cut-off current	$I_B = 0; V_{CE} = -50 V$	-	-	-1	μA
		$I_B = 0; V_{CE} = -30 \text{ V}; T_j = 150 \text{ °C}$	-	-	-50	μA
I _{EBO}	emitter cut-off current	$I_{C} = 0; V_{EB} = -5 V$	-	-	-100	nA
h _{FE}	DC current gain	$I_{C} = -1 \text{ mA}; V_{CE} = -5 \text{ V}$	200	-	-	
V _{CEsat}	collector-emitter saturation voltage	$I_{\rm C} = -5 \text{ mA}; I_{\rm B} = -0.25 \text{ mA}$	_	_	-100	mV
R1	input resistor		3.3	4.7	6.1	kΩ
C _c	collector capacitance	$I_E = i_e = 0; V_{CB} = -10 V; f = 1 MHz$	-	_	3	pF

PEMB3

PNP resistor-equipped double transistor $R1 = 4.7 \text{ k}\Omega$, R2 = open

PACKAGE OUTLINE

Plastic surface mounted package; 6 leads



PNP resistor-equipped double transistor R1 = 4.7 k Ω , R2 = open

DATA SHEET STATUS

DATA SHEET STATUS ⁽¹⁾	PRODUCT STATUS ⁽²⁾	DEFINITIONS
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PEMB3

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